

### FM320-AL THRU FM3200-AL

### 3.0A Surface Mount Schottky Barrier Rectifiers - 20V-200V

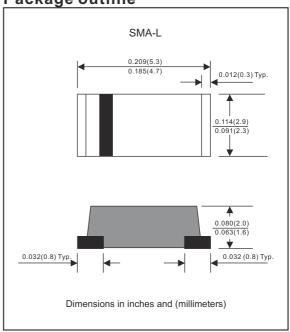
#### **Features**

- Batch process design, excellent power dissipation offers better reverse leakage current and thermal resistance.
- Low profile surface mounted application in order to optimize board space.
- Low power loss, high efficiency.
- High current capability, low forward voltage drop.
- High surge capability.
- Guardring for overvoltage protection.
- Ultra high-speed switching.
- Silicon epitaxial planar chip, metal silicon junction.
- Lead-free parts meet environmental standards of MIL-STD-19500/228
- Compliant to Halogen-free.
- Suffix "-AU" for Automotive.

#### Mechanical data

- Epoxy:UL94-V0 rated flame retardant
- Case: Molded plastic, DO-214AC/SMA-L
- Terminals : Solder plated, solderable per
  - MIL-STD-750, Method 2026
- Polarity: Indicated by cathode band
- Mounting Position : Any

#### Package outline



#### Maximum ratings and Electrical Characteristics (AT T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER	CONDITIONS	Symbol	MIN.	TYP.	MAX.	UNIT
Forward rectified current	See Fig.1	I <sub>o</sub>			3.0	Α
Forward surge current	8.3ms single half sine-wave (JEDEC methode)	I <sub>FSM</sub>			80	Α
	$V_R = V_{RRM} T_J = 25^{\circ}C$				0.5	A
Reverse current	$V_R = V_{RRM} T_J = 100^{\circ}C$	I <sub>R</sub>			20	mA
Thermal resistance	Junction to ambient	R <sub>eJA</sub>		52		°C/W
mermarresistance	Junction to case	R <sub>eJC</sub>		26		°C/W
Diode junction capacitance	f=1MHz and applied 4V DC reverse voltage	C <sub>J</sub>		250		pF
Storage temperature		T <sub>src</sub>	-65		+175	°C

SYMBOLS	V <sub>RRM</sub> *1 (V)	V <sub>RMS</sub> *2 (V)	V <sub>R</sub> *3 (V)	V <sub>F</sub> *4 (V)	Operating temperature T <sub>J</sub> , (°C)	
FM320-AL	20	14	20			
FM330-AL	30	21	30	0.50	-55 to +125	
FM340-AL	40	28	40			
FM350-AL	50	35	50	0.70		
FM360-AL	60	42	60	0.70		
FM380-AL	80	56	80	0.85	FF to 1150	
FM3100-AL	100	70	100	0.00	-55 to +150	
FM3150-AL	150	105	150	0.90		
FM3200-AL	200	140	200	0.92		

- \*1 Repetitive peak reverse voltage
- \*2 RMS voltage
- \*3 Continuous reverse voltage
- \*4 Maximum forward voltage@I<sub>F</sub>=3.0A

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#### Rating and characteristic curves (FM320-AL THRU FM3200-AL)

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

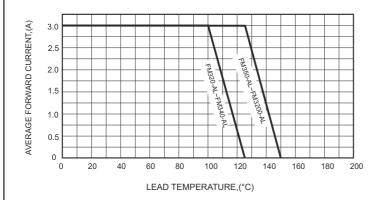


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

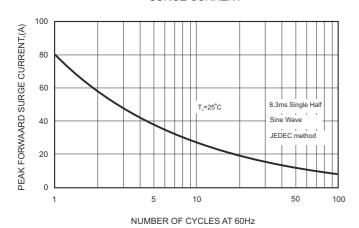


FIG.4-TYPICAL JUNCTION CAPACITANCE

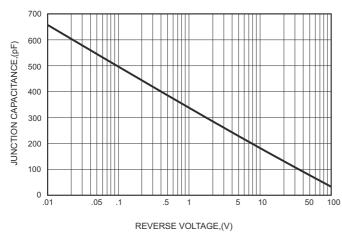


FIG.2-TYPICAL FORWARD

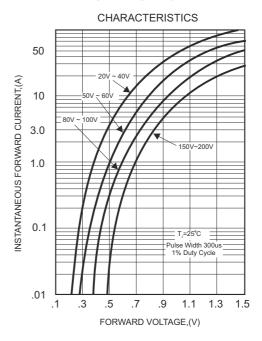
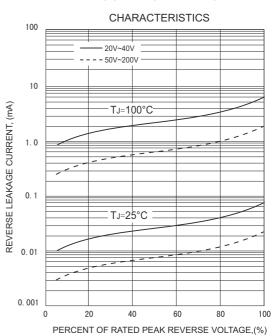


FIG.5 - TYPICAL REVERSE





### FM320-AL THRU FM3200-AL

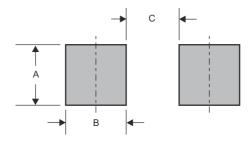
### **Pinning information**

Pin	Simplified outline	Symbol
Pin1 cathode Pin2 anode	1 2	12

### Marking

Type number	Marking code
FM320-AL	SS32
FM330-AL	SS33
FM340-AL	SS34
FM350-AL	SS35
FM360-AL	SS36
FM380-AL	SS38
FM3100-AL	S310
FM3150-AL	S315
FM3200-AL	S320

#### Suggested solder pad layout



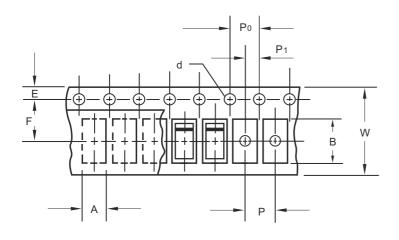
Dimensions in inches and (millimeters)

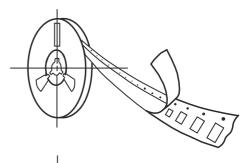
PACKAGE	А	В	С
SMA-L	0.110 (2.80)	0.059 (1.50)	0.110 (2.80)

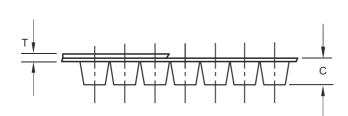
# Formosa MS

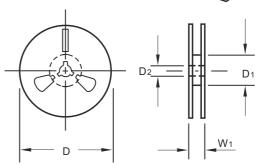
## FM320-AL THRU FM3200-AL

### **Packing information**









unit:mm

Item	Symbol	Tolerance	SMA-L
Carrier width	Α	0.1	2.90
Carrier length	В	0.1	5.50
Carrier depth	С	0.1	2.10
Sprocket hole	d	0.1	1.50
13" Reel outside diameter	D	2.0	330.00
13" Reel inner diameter	D1	min	50.00
7" Reel outside diameter	D	2.0	178.00
7" Reel inner diameter	D1	min	62.00
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	Е	0.1	1.75
Punch hole position	F	0.1	5.50
Punch hole pitch	Р	0.1	4.00
Sprocket hole pitch	P <sub>0</sub>	0.1	4.00
Embossment center	P1	0.1	2.00
Overall tape thickness	Т	0.1	0.23
Tape width	W	0.3	12.00
Reel width	W1	1.0	18.00

 $Note: Devices \ are \ packed \ in \ accordance \ with \ EIA \ standar \ RS-481-A \ and \ specifications \ listed \ above.$ 

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# Formosa MS

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#### Reel packing

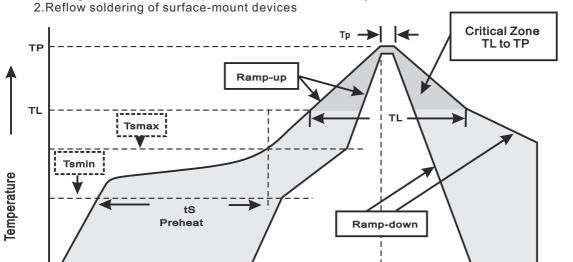
PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (m/m)	BOX (pcs)	INNER BOX (m/m)	REEL DIA, (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SMA-L	7"	2,000	4.0	20,000	183*155*183	178	382*356*392	160,000	15.5
SWA-L	7"	2,000	4.0	10,000	180*180*80	178	440*410*220	100,000	13.0

#### Suggested thermal profiles for soldering processes

t25°C to Peak

Time

1.Storage environment: Temperature=5°C~40°C Humidity=55%±25%



3.Reflow soldering

Profile Feature	Soldering Condition
Average ramp-up rate(T∟ to T <sub>P</sub> )	<3°C/sec
Preheat -Temperature Min(Tsmin) -Temperature Max(Tsmax) -Time(min to max)(ts)	150°C 200°C 60~120sec
Tsmax to T∟ -Ramp-upRate	<3°C/sec
Time maintained above: -Temperature(TL) -Time(tL)	217°C 60~260sec
Peak Temperature(T♭)	255°C-0/+5°C
Time within 5°C of actual Peak Temperature(t <sub>P</sub> )	10~30sec
Ramp-down Rate	<6°C/sec
Time 25°C to Peak Temperature	<6minutes

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